

Product Summary

V_{BR} (min)	I_{PP} (max)	I_R (max)
24V	100A	200nA

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ± 30 kV, Contact ± 30 kV
- One Channels of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: U-DFN2020-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- ④ Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ④
- Weight: 0.004 grams (Approximate)



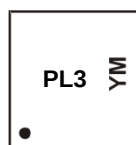
Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D22V0S1U2LP20-7	Standard	PL3	7	8	3000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



PL3 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: B = 2014)
M = Month (ex: 9 = September)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	4000	W	8/20μs (Note 7)
Peak Pulse Current	I _{PP}	100	A	8/20μs (Note 7)
ESD Protection – Contact Discharge	V _{ESD Contact}	±30	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD Air}	±30	kV	Standard IEC 61000-4-2

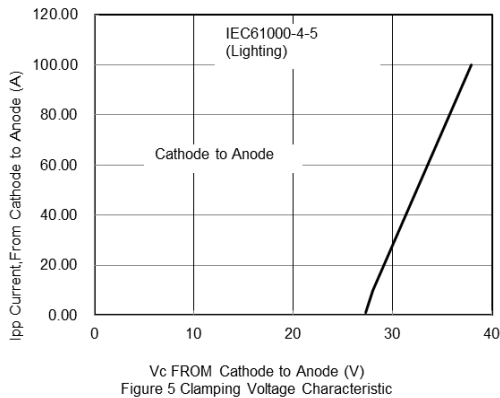
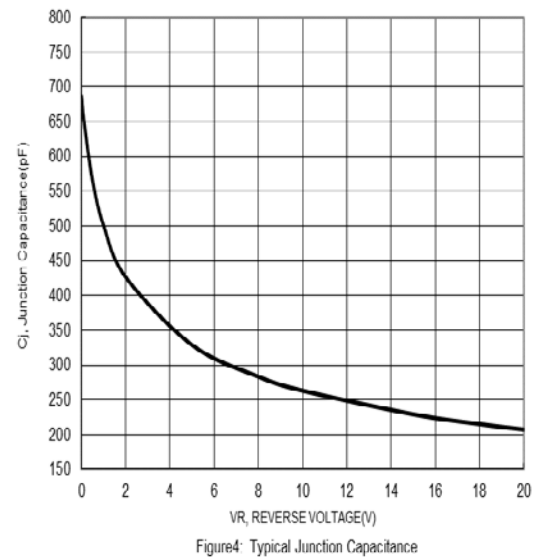
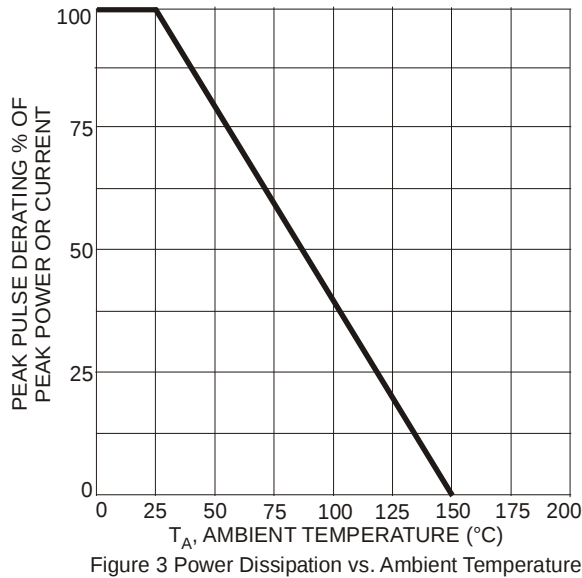
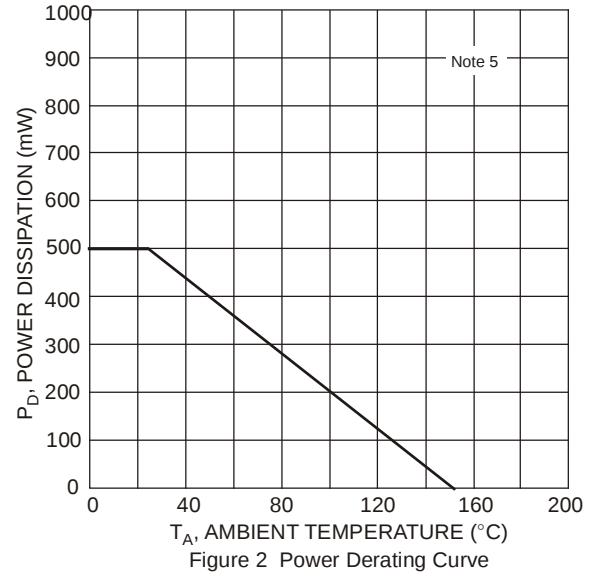
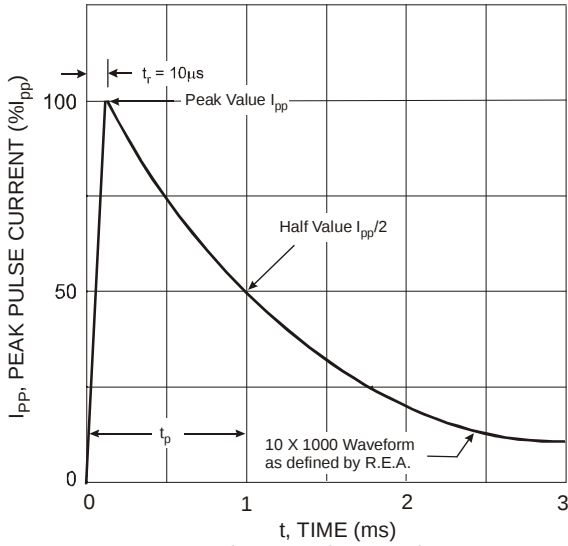
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	500	mW
Thermal Resistance, Junction to Ambient T _A = +25°C	R _{θJA}	250	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	—	—	22	V	—
Channel Leakage Current (Note 6)	I _R	—	—	200	nA	V _R = 22V
Forward Voltage	V _F	0.6	0.8	1.2	V	I _R = 10mA
Reverse Breakdown Voltage	V _{BR}	24	—	—	V	I _R = 1mA
Clamping Voltage, Positive Transients (Note 7)	V _C	—	—	30	V	I _{PP} = 1A, t _p = 8/20μs
		—	—	30	V	I _{PP} = 10A, t _p = 8/20μs
		—	—	40	V	I _{PP} = 100A, t _p = 8/20μs
Channel Input Capacitance (Note 8)	C _T	—	690	—	pF	V _R = 0V, f = 1MHz

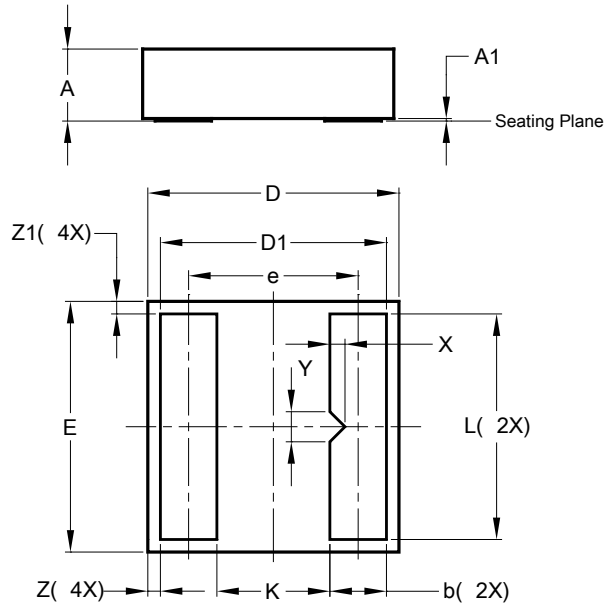
- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
 - Short duration pulse test used to minimize self-heating effect.
 - Clamping voltage value is based on an 8 × 20μs peak pulse current (I_{PP}) waveform.
 - Measured from any I/O to GND.
 - For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at <https://www.diodes.com/assets/App-Note-Files/AN77.pdf>.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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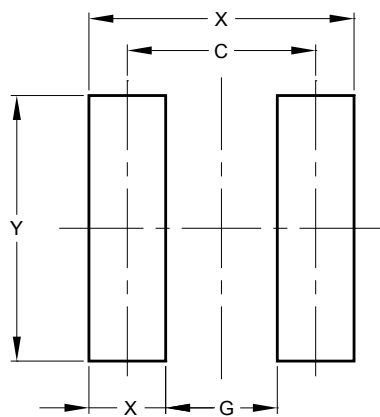


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Dim	Min	Max	Typ
A	0.545	0.605	0.575
A1	0	0.05	0.02
b	0.35	0.55	0.45
D	1.90	2.10	2.00
D1	1.70	1.90	1.80
E	1.90	2.10	2.00
e	1.35 BSC		
K	0.80	1.00	0.90
L	1.70	1.90	1.80
X	—	—	0.120
Y	—	—	0.240
Z	0.10 BSC		
Z1	0.10 BSC		
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

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Dimensions	Value (in mm)
C	1.350
G	0.800
X	0.550
X1	1.900
Y	1.900

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